L Number	Hits	Search Text	DB	Time stamp
_	561	(156/166).CCLS.	USPAT;	2004/06/24 10:59
			US-PGPUB;	
		·	EPO; JPO;	
			DERWENT;	
	1		IBM TDB	
_	737	(156/167).CCLS.	USPAT;	2004/06/24 10:59
	'''	(100/101).0000	US-PGPUB;	
			EPO; JPO;	
	, ,		DERWENT;	
			IBM TDB	
	44	(156/168).CCLS.	USPAT;	2004/06/24 10:59
-	] "	(188) 188).8828.	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	410	(156/169).CCLS.	USPAT;	2004/06/24 10:59
-	410	(130/109).CCE3.	US-PGPUB;	2004/00/24 10:00
			EPO; JPO;	
		,	DERWENT;	
			IBM_TDB	
	440	(450(470) 00) 0		2004/06/24 10:59
-	112	(156/170).CCLS.	USPAT;	2004/00/24 10.59
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	0004/00/04 40 50
-	305	(156/171).CCLS.	USPAT;	2004/06/24 10:59
ļ			US-PGPUB;	
	}		EPO; JPO;	
İ			DERWENT;	
	,		IBM_TDB	
-	822	(156/172).CCLS.	USPAT;	2004/06/24 10:59
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	729	(156/173).CCLS.	USPAT;	2004/06/24 10:59
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	241	(156/174).CCLS.	USPAT;	2004/06/24 10:59
ļ			US-PGPUB;	
ì			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	558	(156/175).CCLS.	USPAT;	2004/06/24 10:59
		,	US-PGPUB;	
	1		EPO; JPO;	
			DERWENT,	
			IBM TDB	
-	297	(156/176).CCLS.	USPAT;	2004/06/24 10:59
			US-PGPUB;	
			EPO; JPO;	
	1		DERWENT;	
1			IBM_TDB	
	265	(156/177).CCLS.	USPAT;	2004/06/24 10:59
1	200	(100/177).0020.	US-PGPUB;	230 1100124 10.00
			EPO; JPO;	
1			DERWENT;	
			IBM TDB	
1	1	1	ם עו _ואוםו ן	1

-	440	(156/178).CCLS.	USPAT;	2004/06/24 10:59
			US-PGPUB;	
			EPO; JPO;	ļ
			DERWENT;	
			IBM_TDB	
-	336	(156/179).CCLS.	USPAT;	2004/06/24 10:59
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	836	(156/180).CCLS.	USPAT;	2004/06/24 10:59
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-	842	(156/181).CCLS.	USPAT;	2004/06/24 10:59
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			IBM_TDB	
_	709	(156/184).CCLS.	USPAT;	2004/06/24 10:59
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	338	(156/185).CCLS.	USPAT;	2004/06/24 10:59
		(100/100).0020.	US-PGPUB;	·
			EPO; JPO;	
			DERWENT;	
1			IBM_TDB	
1_	66	(156/186).CCLS.	USPAT;	2004/06/24 10:59
		(100/100).0020.	US-PGPUB;	
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			DERWENT;	
1			IBM_TDB	
1_	752	(156/187).CCLS.	USPAT;	2004/06/24 10:59
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			DERWENT;	
			IBM_TDB	
1_	256	(156/188).CCLS.	USPAT;	2004/06/24 10:59
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1			EPO; JPO;	
			DERWENT;	
1	1		IBM_TDB	
1_	340	(156/189).CCLS.	USPAT;	2004/06/24 10:59
1		(	US-PGPUB;	
1			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
1_	438	(156/190).CCLS.	USPAT;	2004/06/24 10:59
1		(,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	US-PGPUB;	
1			EPO; JPO;	
1			DERWENT;	
			IBM_TDB	
1_	423	(156/191).CCLS.	USPAT;	2004/06/24 10:59
1	725	(100, 101), 0020.	US-PGPUB;	
1	1		EPO; JPO;	
1			DERWENT;	
1			IBM_TDB	
1_	388	(156/192).CCLS.	USPAT;	2004/06/24 10:59
<del>-</del>		1	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
1	<u> </u>		1 .0 00	l

	1 000	[ (450(400) 00] O	LICDAT	0004/00/04 40:50
-	289	(156/193).CCLS.	USPAT; US-PGPUB;	2004/06/24 10:59
			EPO; JPO;	
			DERWENT:	
			IBM TDB	İ
1_	311	(156/194).CCLS.	USPAT;	2004/06/24 10:59
-	311	(130/134).CCLG.	US-PGPUB;	2004/00/24 10:55
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	752	(156/195).CCLS.	USPAT;	2004/06/24 10:59
	, , , ,	(100/100).0020.	US-PGPUB;	200 1100/21 10:00
			EPO; JPO;	·
			DERWENT;	
			IBM_TDB	
_	7059	((156/166).CCLS.) ((156/167).CCLS.) ((156/168).CCLS.)	USPAT	2004/06/24 10:59
	, , , ,	((156/169).CCLS.) ((156/170).CCLS.) ((156/171).CCLS.)	55. 7.1	200 1/00/21 10:00
		((156/172).CCLS.) ((156/173).CCLS.) ((156/174).CCLS.)		
		((156/175).CCLS.) ((156/176).CCLS.) ((156/177).CCLS.)	,	
		((156/178).CCLS.) ((156/179).CCLS.) ((156/180).CCLS.)		
		((156/181).CCLS.) ((156/184).CCLS.) ((156/185).CCLS.)		
		((156/186).CCLS.) ((156/187).CCLS.) ((156/188).CCLS.)		*
		((156/189).CCLS.) ((156/190).CCLS.) ((156/191).CCLS.)		
		((156/192).CCLS.) ((156/193).CCLS.) ((156/194).CCLS.)		
		((156/195).CCLS.)		
-	8511	((156/166).CCLS.) ((156/167).CCLS.) ((156/168).CCLS.)	USPAT;	2004/06/24 10:59
1		((156/169).CCLS.) ((156/170).CCLS.) ((156/171).CCLS.)	US-PGPUB;	
		((156/172).CCLS.) ((156/173).CCLS.) ((156/174).CCLS.)	EPO; JPO;	
		((156/175).CCLS.) ((156/176).CCLS.) ((156/177).CCLS.)	DERWENT:	
		((156/178).CCLS.) ((156/179).CCLS.) ((156/180).CCLS.)	IBM TDB	
		((156/181).CCLS.) ((156/184).CCLS.) ((156/185).CCLS.)	<del>-</del> .	
		((156/186).CCLS.) ((156/187).CCLS.) ((156/188).CCLS.)		
		((156/189).CCLS.) ((156/190).CCLS.) ((156/191).CCLS.)		
		((156/192).CCLS.) ((156/193).CCLS.) ((156/194).CCLS.)		
		((156/195).CCLS.)		
-	3	(fiber near2 (placement)) and(molecular near10 mobility)	USPAT;	2004/06/24 10:59
			US-PGPUB;	
İ			EPO; JPO;	
			DERWENT;	
İ	_		IBM_TDB	
<b> -</b>	3	(fiber near2 (placement)) and (molecular near10 mobility)	USPAT;	2004/06/24 10:59
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
1		("C00C1C4") DN	IBM_TDB	2004/06/24 40:50
-	1 250	("6096164").PN.	USPAT	2004/06/24 10:59
-	358	(156/351).CCLS.	USPAT;	2004/06/24 10:59
			US-PGPUB; EPO; JPO;	
1	1		DERWENT;	
			IBM_TDB	
_	3	(("5698066") or ("5580413") or ("5228050")).PN.	USPAT	2004/06/24 10:59
1	7	((3090000) of (3300413) of (3220030)).FN. (collation near2 (machine or apparatus or head)) and (laser	USPAT;	2004/06/24 10:59
-	1	near3 diode)	US-PGPUB;	2007/00/24 10.08
		Hours diodoj	EPO; JPO;	
1			DERWENT;	
			IBM TDB	
-	3	(compaction near2 (machine or apparatus or head)) and	USPAT;	2004/06/24 10:59
		(laser near3 diode)	US-PGPUB;	
		(	EPO; JPO;	
			DERWENT;	
			IBM TDB	
<b></b>		L		

[	117	(fiber near2 (placement)) and (laser near3 diode)	USPAT;	2004/06/24 10:59
_		(inder riear2 (placement)) and (laser riears diode)	US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/00/24 10.09
-	1	((((156/166).CCLS.) ((156/167).CCLS.) ((156/168).CCLS.) ((156/169).CCLS.) ((156/170).CCLS.) ((156/171).CCLS.) ((156/172).CCLS.) ((156/173).CCLS.) ((156/174).CCLS.) ((156/175).CCLS.) ((156/176).CCLS.) ((156/177).CCLS.) ((156/178).CCLS.) ((156/179).CCLS.) ((156/180).CCLS.) ((156/181).CCLS.) ((156/184).CCLS.) ((156/185).CCLS.) ((156/186).CCLS.) ((156/187).CCLS.) ((156/188).CCLS.) ((156/189).CCLS.) ((156/190).CCLS.) ((156/191).CCLS.) ((156/192).CCLS.) ((156/193).CCLS.) ((156/194).CCLS.) ((156/195).CCLS.)) ((156/195).CCLS.) ((156/195).CCLS.) ((156/195).CCLS.) ((156/195).CCLS.)) and (laser near3 array) and (laser near3 diode)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:59
_	6	(((156/166).CCLS.) ((156/167).CCLS.) ((156/168).CCLS.) ((156/169).CCLS.) ((156/170).CCLS.) ((156/171).CCLS.) ((156/172).CCLS.) ((156/173).CCLS.) ((156/174).CCLS.) ((156/175).CCLS.) ((156/176).CCLS.) ((156/177).CCLS.) ((156/178).CCLS.) ((156/179).CCLS.) ((156/180).CCLS.) ((156/181).CCLS.) ((156/184).CCLS.) ((156/185).CCLS.) ((156/186).CCLS.) ((156/187).CCLS.) ((156/188).CCLS.) ((156/189).CCLS.) ((156/190).CCLS.) ((156/191).CCLS.) ((156/192).CCLS.) ((156/193).CCLS.) ((156/194).CCLS.) ((156/195).CCLS.)) and (laser near3 diode)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:59
-	3	(((156/166).CCLS.) ((156/167).CCLS.) ((156/168).CCLS.) ((156/169).CCLS.) ((156/170).CCLS.) ((156/171).CCLS.) ((156/172).CCLS.) ((156/173).CCLS.) ((156/174).CCLS.) ((156/175).CCLS.) ((156/176).CCLS.) ((156/177).CCLS.) ((156/178).CCLS.) ((156/179).CCLS.) ((156/180).CCLS.) ((156/181).CCLS.) ((156/184).CCLS.) ((156/185).CCLS.) ((156/186).CCLS.) ((156/187).CCLS.) ((156/188).CCLS.) ((156/189).CCLS.) ((156/190).CCLS.) ((156/191).CCLS.) ((156/192).CCLS.) ((156/193).CCLS.) ((156/194).CCLS.) ((156/195).CCLS.)) and (laser near3 array)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:59
-	422	(156/359).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/24 10:59
-	363	(156/358).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/24 11:00
-	185	(fiber near2 (placement)) and (camera or CCD)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:59
-	1 52	("5066352").PN. (fiber near2 (placement)) and (pressure near2 control)	USPAT USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/06/24 11:00 2004/06/24 11:00
-	27	(fiber near2 (tape)) and (pressure near2 control)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 11:00

-	356	(156/379.6).CCLS.	USPAT;	2004/06/24 11:01
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	227	(156/380.9).CCLS.	USPAT;	2004/06/24 11:04
		, ·	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	621	(156/378).CCLS.	USPAT;	2004/06/24 11:04
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	170	(156/379).CCLS.	USPAT;	2004/06/24 11:04
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
ł			IBM_TDB	



Day: Thursday Date: 6/24/2004

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### **Inventor Name Search Result**

Your Search was:

Last Name = HOLMES First Name = SCOTT

Application#	Patent#	Status	Date Filed	Title	Inventor Name 10
60194847	Not Issued	159	04/05/2000	TOP DOWN HORIZONTAL BLIND FOR REGULAR AND UNUSUALLY SHAPED WINDOWS	HOLMES, SCOTT DAVID
10664148	Not Issued	071	09/17/2003	COMPOSITE MATERIAL COLLATION MACHINE AND ASSOCIATED METHOD FOR HIGH RATE COLLATION OF COMPOSITE MATERIALS	HOLMES, SCOTT T.
10068735	Not Issued	120	02/06/2002	COMPOSITE MATERIAL COLLATION MACHINE AND ASSOCIATED METHOD FOR HIGH RATE COLLATION OF COMPOSITE MATERIALS	HOLMES, SCOTT T.
09899701	6503150	150	07/05/2001	GOLF PRACTICE DEVICE	HOLMES, SCOTT TRAVIS
09819922	Not Issued	030	03/28/2001	SYSTEM AND METHOD FOR IDENTIFYING DEFECTS IN A COMPOSITE STRUCTURE	HOLMES, SCOTT T.
09578069	6451152	150	05/24/2000	METHOD FOR HEATING AND CONTROLLING TEMPERATURE OF COMPOSITE MATERIAL DURING AUTOMATED PLACEMENT	HOLMES, SCOTT
08936632	6159705	150	09/24/1997	RECOMBINANT YEAST CELLS FOR IDENTIFYING RECEPTOR EFFECTORS	HOLMES, SCOTT
08580990	Not Issued	161	01/03/1996	THERALOSS/RX	HOLMES , SCOTT
08240279	5626471	150		ADJUSTABLE HOT GAS TORCH NOZZLE AND A METHOD FOR RAPID HEATING CONTROL	HOLMES , SCOTT

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07699378 | 5225025 | 150 | 05/14/1991 | APPARATUS AND METHOD | HOLMES, SCOTT | FOR RESISTANCE WELDING

Inventor Search Completed: No Records to Display.

Search Another: Inventor HOLMES First Name

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#### **Inventor Name Search Result**

Your Search was:

Last Name = MCILROY

First Name = BRUCE

Application#	Patent#	Status	Date Filed	Title	Inventor Name 5
10664148	Not Issued	071	09/17/2003	COMPOSITE MATERIAL COLLATION MACHINE AND ASSOCIATED METHOD FOR HIGH RATE COLLATION OF COMPOSITE MATERIALS	MCILROY, BRUCE E.
10068735	Not Issued	120	02/06/2002	COMPOSITE MATERIAL COLLATION MACHINE AND ASSOCIATED METHOD FOR HIGH RATE COLLATION OF COMPOSITE MATERIALS	MCILROY, BRUCE E.
09126561	6066389	150	07/30/1998	CONNECTOR TOW	MCILROY , BRUCE E.
09126550	5979046	150		COMPOSITE STRUCTURE HAVING AN EXTERNALLY ACCESSIBLE ELECTRICAL DEVICE EMBEDDED THEREIN AND A RELATED FABRICATION METHOD	MCILROY , BRUCE E.
<u>08473098</u>	<u>5851645</u>	150	06/07/1995	COMPOSITE STRUCTURE HAVING AN EXTERNALLY ACCESSIBLE ELECTRICAL DEVICE EMBEDDED THEREIN AND A RELATED FABRICATION METHOD	MCILROY , BRUCE E.

Inventor Search Completed: No Records to Display.

**Last Name** First Name Search Another: Inventor MCILROY BRUCE Search

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### **Inventor Name Search Result**

Your Search was:

Last Name = ENGELBART

First Name = ROGER

Application#	Patent#				Inventor Name 9
10822538	Not Issued	020		SYSTEMS AND METHODS FOR USING LIGHT TO INDICATE DEFECT LOCATIONS ON A COMPOSITE STRUCTURE	ENGELBART, ROGER W.
10799306	Not Issued	020		SYSTEMS AND METHODS ENABLING AUTOMATED RETURN TO AND/OR REPAIR OF DEFECTS WITH A MATERIAL PLACEMENT MACHINE	ENGELBART, ROGER W.
10726099	Not Issued	020	12/02/2003	SYSTEMS AND METHODS FOR DETERMINING DEFECT CHARACTERISTICS OF A COMPOSITE STRUCTURE	ENGELBART, ROGER W.
10664148	Not Issued	071	09/17/2003	COMPOSITE MATERIAL COLLATION MACHINE AND ASSOCIATED METHOD FOR HIGH RATE COLLATION OF COMPOSITE MATERIALS	ENGELBART, ROGER W.
10628691	Not Issued	168	07/28/2003	SYSTEMS AND METHODS FOR IDENTIFYING FOREIGN OBJECTS AND DEBRIS (FOD) AND DEFECTS DURING FABRICATION OF A COMPOSITE STRUCTURE	ENGELBART, ROGER W.
10459957	Not Issued	030	06/11/2003	APPARATUS AND METHODS FOR NON-DESTRUCTIVE INSPECTION USING MICROWAVE SENSING	ENGELBART, ROGER W.
10217805	Not Issued	071	08/13/2002	SYSTEM FOR IDENTIFYING DEFECTS IN A COMPOSITE STRUCTURE	ENGELBART, ROGER W.
10068735	Not	120	02/06/2002	COMPOSITE MATERIAL	ENGELBART,

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	Issued		COLLATION MACHINE AND ASSOCIATED METHOD FOR HIGH RATE COLLATION OF COMPOSITE MATERIALS	ROGER W.
09819922	Not Issued	030	SYSTEM AND METHOD FOR IDENTIFYING DEFECTS IN A COMPOSITE STRUCTURE	II ' ' I

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### **Inventor Name Search Result**

Your Search was:

Last Name = LAWTON First Name = STANLEY

Application#	Patent#				Inventor Name 6
10664148	Not Issued	071	09/17/2003	COMPOSITE MATERIAL COLLATION MACHINE AND ASSOCIATED METHOD FOR HIGH RATE COLLATION OF COMPOSITE MATERIALS	LAWTON, STANLEY A.
10068735	Not Issued	120	02/06/2002	COMPOSITE MATERIAL COLLATION MACHINE AND ASSOCIATED METHOD FOR HIGH RATE COLLATION OF COMPOSITE MATERIALS	LAWTON, STANLEY A.
09578069	6451152	150	05/24/2000	METHOD FOR HEATING AND CONTROLLING TEMPERATURE OF COMPOSITE MATERIAL DURING AUTOMATED PLACEMENT	LAWTON, STANLEY A.
09451284	6347976	150	11/30/1999	COATING REMOVAL SYSTEM HAVING A SOLID PARTICLE NOZZLE WITH A DETECTOR FOR DETECTING PARTICLE FLOW AND ASSOCIATED METHOD	LAWTON , STANLEY ALLEN
08650644	Not Issued	148	05/23/1996	ELECTROMAGNETIC ABSORPTION SYSTEMS USING SOLID ACTIVE MATERIAL	LAWTON , STANLEY A.
08228592	5427763	250	04/15/1994	METHOD FOR MAKING VANADIUM DIOXIDE POWDERS	LAWTON , STANLEY A.

Inventor Search Completed: No Records to Display.

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